

P-Channel 60-V (D-S) MOSFET

PRODUC	T SUMMARY		
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ)
- 60	0.100 at V _{GS} = - 10 V	- 20	12.5
- 60	0.120 at V _{GS} = - 4.5 V	- 15	12.3

FEATURES

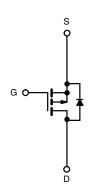
- Trench Power MOSFET
- 100 % UIS Tested

APPLICATIONS

Load Switch







P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_C = 2$	25 °C, unless othe	rwise noted		
Parameter		Symbol	Limit	Unit
Gate-Source Voltage		V _{GS}	± 20	V
Continuous Drain Current (T _{.I} = 175 °C)	T _C = 25 °C	I-	- 20	
Continuous Drain Current (1) = 175 C)	T _C = 100 °C	- 12		
Pulsed Drain Current		I _{DM}	- 60	Α
Continuing Source Current (Diode Conduction)		I _S	- 12	
Avalanche Current		I _{AS}	- 12	
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	7.2	mJ
Maximum Power Dissipation	T _C = 25 °C	P _D	30 ^a	W
Maximum Fower Dissipation	T _A = 25 °C	' D	2 ^b	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
hunding to Ambient	t ≤ 10 sec	R _{thJA}	20 25			
Junction-to-Ambient ^D	Steady State	' 'thJA	62	75	°C/W	
Junction-to-Case		R _{thJC}	5	6		

Notes:

- a. See SOA curve for voltage derating.
- b. Surface Mounted on 1" x 1" FR-4 boad.

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1



SPECIFICATIONS $T_J = 25$	°C, unless	otherwise noted				
Parameter	Symbol	Test Conditions	Min	Typ ^a	Max	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 60			V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.0	- 2.0	- 3.0	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
		V _{DS} = - 60 V, V _{GS} = 0 V			- 1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 125 °C			- 50	μΑ
		V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 175 °C			- 150	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 10			Α
		V _{GS} = - 10 V, I _D = - 5 A		0.100		
D : 0	r	V _{GS} = - 10 V, I _D = - 5 A, T _J = 125 °C		0.150		Ω
Drain-Source On-State Resistance ^b	r _{DS(on)} V _{GS} = - 10 V	V _{GS} = - 10 V, I _D = - 5 A, T _J = 175 °C		0.200		
		V _{GS} = - 4.5 V, I _D = - 2 A		0.120		
Forward Transconductance ^b	9 _{fs}	V _{DS} = - 15 V, I _D = - 5 A		8		S
Dynamic	•			*		
Input Capacitance	C _{iss}			550		
Output Capacitance	C _{oss}	V _{DS} = - 25 V, V _{GS} = 0 V, f = 1 MHz		95		pF
Reverse Transfer Capacitance	C _{rss}			60		
Total Gate Charge	Q_g			12.5	19	
Gate-Source Charge	Q _{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -8.4 \text{ A}$		2.3		nC
Gate-Drain Charge	Q_{gd}]		3.2		
Gate Resistance	R_{g}	f = 1 MHz		8.0		Ω
Turn-On Delay Time ^c	t _{d(on)}			5	10	
Rise Time ^c	t _r	$V_{DD} = -30 \text{ V}, R_L = 3.57 \Omega$		14	25	ns
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -8.4 \text{ A}, V_{GEN} = -10 \text{ V}, R_G = 2.5 \Omega$		15	25	
Fall Time ^c	t _f] [7	12	
Source-Drain Diode Ratings and Cha	aracteristics	(T _C = 25 °C) ^b		•		
Pulsed Current	I _{SM}				- 20	Α
Forward Voltage ^b	V_{SD}	I _F = - 2 A, V _{GS} = 0 V		- 0.9	- 1.3	٧
Reverse Recovery Time	t _{rr}	I _F = - 8 A, di/dt = 100 A/μs		50	80	ns
Reverse Recovery Time	Q _{rr}	- i _F = - δ A, αι/αι = 100 A/μS		80	120	pF nC Ω

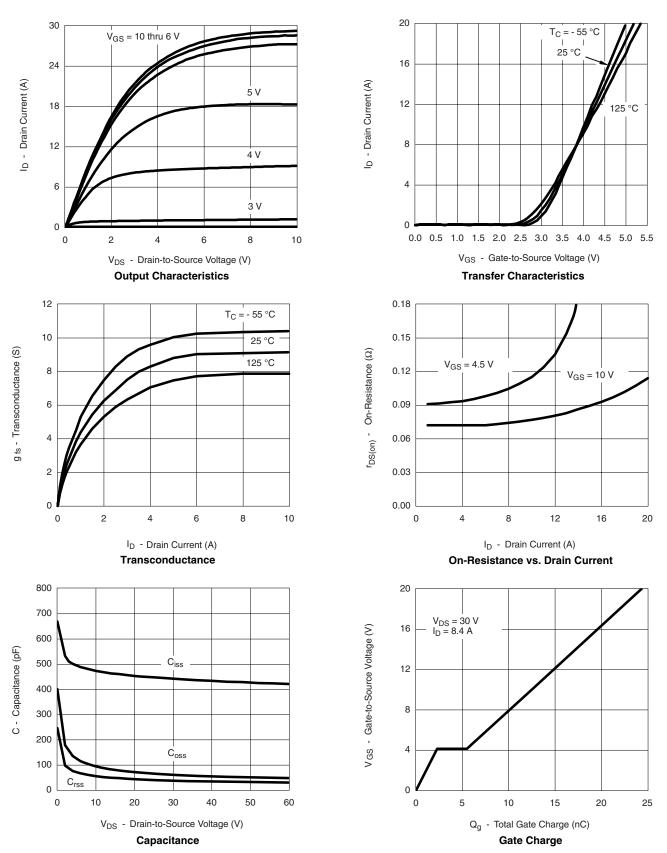
Notes:

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

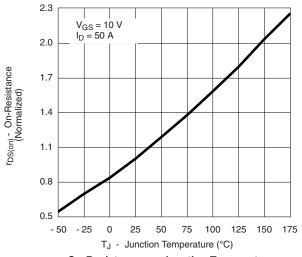


TYPICAL CHARACTERISTICS 25 °C unless noted

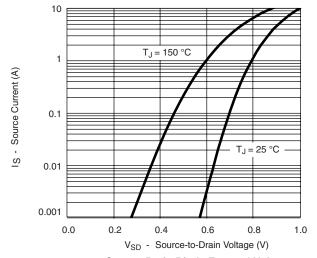




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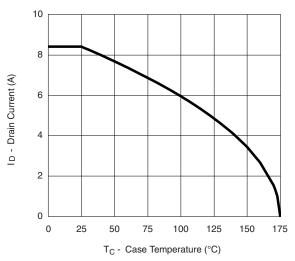




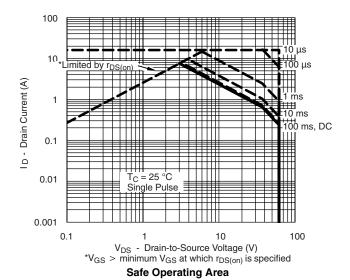


Source-Drain Diode Forward Voltage

THERMAL RATINGS

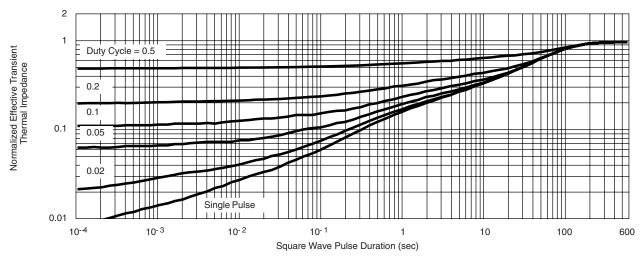


Drain Current vs. Case Temperature

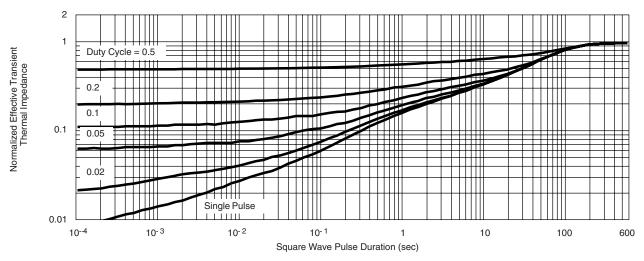




THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Ambient

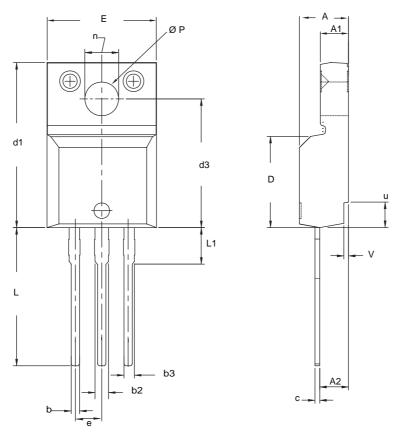


Normalized Thermal Transient Impedance, Junction-to-Case

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TO-220 FULLPAK



DIM.	MILLIN	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.		
Α	4.570	4.830	0.180	0.190		
A1	2.570	2.830	0.101	0.111		
A2	2.510	2.850	0.099	0.112		
b	0.622	0.890	0.024	0.035		
b2	1.229	1.400	0.048	0.055		
b3	1.229	1.400	0.048	0.055		
С	0.440	0.629	0.017	0.025		
D	8.650	9.800	0.341	0.386		
d1	15.88	16.120	0.622	0.635		
d3	12.300	12.920	0.484	0.509		
Е	10.360	10.630	0.408	0.419		
е	2.54	BSC	0.100	0.100 BSC		
L	13.200	13.730	0.520	0.541		
L1	3.100	3.500	0.122	0.138		
n	6.050	6.150	0.238	0.242		
ØΡ	3.050	3.450	0.120	0.136		
u	2.400	2.500	0.094	0.098		
V	0.400	0.500	0.016	0.020		

DWG: 5972

Notes

- To be used only for process drawing.
 These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
 All critical dimensions should C meet C_{pk} > 1.33.
 All dimensions include burrs and plating thickness.
 No chipping or package damage.



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